SPECIFICATION SHEET

PLCC-2 TOP LED RED COLOR CASE 3528 BDC SERIES

SPECIFICATION SHEET NO.	S0515 – BDCER000000S00	
ORIGINAL MFG/PART NO.	Oriental Technology/BDC-ER-000000	
NEXTGEN PART CODE	BDCER000000S00	Indicate This Code for RFQ /Order
DATE	May 15, 2025	
REVISION	A4	Updated With Most Recent Data
DESCRIPTION AND MAIN PARAMETRICS	Automotive PLCC-2 TOP LED SMD 3528 0.1w Red Color L3.50*W2.80*H1. 80mm, Colorless & Clear Lens Transparency, 2.5mm Dia. Viewing Angle 60 °, Lens Round with Domed Top Forward Voltage (VF) 1.8~2.4V Dominant Wavelength Rank (DWL) 616~628nm Luminous Intensity Rank (IV) 1460~4580mcd Operating Temp. Range -40°C ~+110°C, Package in Tape/Reel, REACH/RoHS/RoHS III Compliant	
CUSTOMER		
CUSTOMER PART NUMBER		
CROSS REF. PART NUMBER		
MEMO		

VENDOR APPROVE
Issued/Checked/Approved Mandy Xu · Ruby Zhang · Jack Zhang
Effective Date: May 15, 2025

CUSTOMER APPROVE
Date:

MAIN FEATURE

- Red Color PLCC-2 Package
- Emitting Material: InGaAIP Chip
- Low Light Attenuation and High Brightness
- Luminous Intensity@20mA: 1460~4580mcd
- View Angle at 50% Iv of 60°
- 100% Pure Gold Wire
- Excellent Stability and Thermostability
- Corrosion Robustness: Excellent Corrosion Robustness
- Suitable for SMT process
- Meet MSL 2A Requirement
- Cross Competitors Parts and More.
- RoHS/RoHS III compliant, RoHS Annex III lead Exemption (Exempt per RoHS EU 2015/863)

RED

Image shown is a representation only. Exact specifications should be obtained from the product dimension.

RoHS COMPLIANT

REACH

APPLICATION

- Auto Signaling
- Auto Lighting Interior and Exterior
- Signal and Symbol Luminary

ELECTRICAL CHARACTERISTICS

- See Page 5 ~ Page 6 For Different Part Code.
- All Products Parameters are Subject To NextGen Components' Final Confirmation.

HOW TO ORDER

- Please Follow Up Part Code Guide And Indicate NextGen Part Code BDCER000000S00 For RFQ and Order.

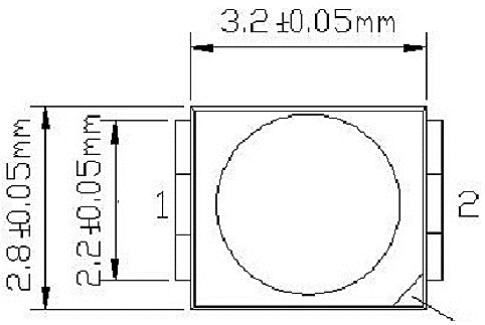
PART CODE GUIDE

RFQ
Request For Quotation

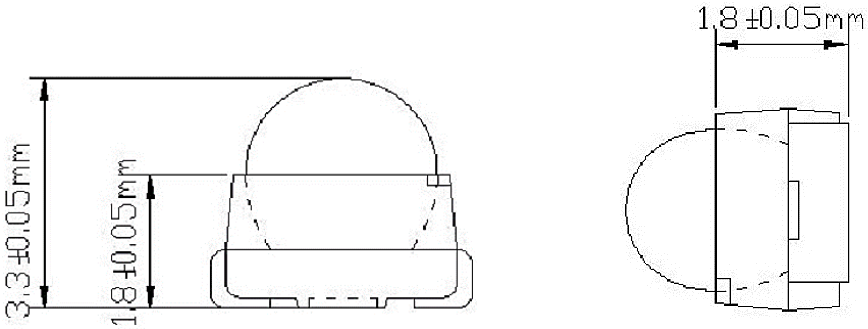
CODE	NAME	KEY SPECIFICATION OPTION
BDC	Product Series Code	Automotive SMD LED PLCC-2 with lens 60° Case 3528 Dimension L3.50*W2.80*H1.80mm
E	Internal Control Code	Custom letter A~Z, a-z or digits (0-9)
R	Color Code	R: Red Color
00	Forward Voltage Rank (VF)	Custom letter A~Z, a-z or digits (0-9) 00: 1.8V ~2.4V; Va: 1.8V ~1.95V; Vb: 1.95V ~2.1V Vc: 2.1V ~2.25V; Vd: 2.25V ~2.4V
00	Dominant Wavelength Rank (DWL)	Custom letter A~Z, a-z or digits (0-9) 00: 616nm~ 628nm; WF: 616nm~ 620nm; WG: 620nm~624nm; WH: 624nm~ 628nm
00	Luminous Intensity Rank (IV)	Custom letter A~Z, a-z or digits (0-9) 00: 1460mcd ~4580mcd; FB: 1460mcd ~1890mcd FC: 1890mcd ~2290mcd; FD: 2290mcd ~2880mcd; FE: 2880mcd ~3600mcd; FF: 3600mcd ~4580mcd
S00	Custom Parameters Code	Custom letter A~Z, a-z or digits (0-9)
XX	Special/Custom Parameters Code	Letter or Digits (A~Z, a~z or 0~9) for Special Parametric; Blank: N/A

DIMENSION - Unit: mm, Case 3528, Lens Round with Domed Top

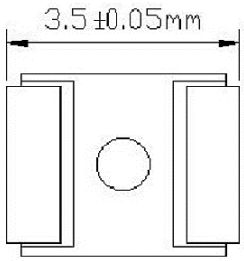
Top View

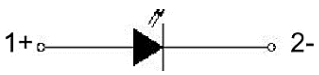


Side View

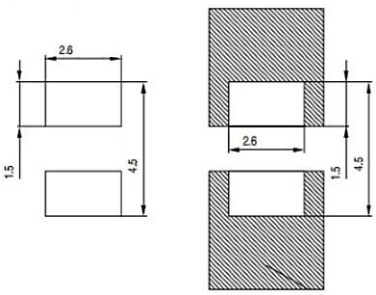


Bottom View





Recommend Pad Layout



MAXIMUM RATINGS - Ts=25℃, RH 60%

PARAMETERS	SYMBOL	VALUES	UNIT
Operating Temperature	Top	-40~+110	℃
Storage Temperature	Tstg	-40~+110	℃
Junction Temperature	Tj	125	℃
Forward Current (Ts=25℃)	I_F	50	mA
Surge Current (t≤10μs; D=0.005; Ts=25℃)	I_{FS}	100	mA
Reverse Voltage (Ts=25℃)	V_R	5	V
Electrostatic Discharge (acc.to ANSI/ESDA/JEDEC JS-001-2017)	V_{ESD}	≥2	kV

OPTICAL & ELECTRICAL CHARACTERISTICS - I_F=20mA, Ts=25℃, RH 60%

PARAMETERS	SYMBOL	VALUES			UNIT
		MIN.	TYP.	MAX.	
Peak Wavelength	λpeak	-	630	-	nm
Dominant wavelength	λdom	616	-	628	nm
Luminous Intensity	IV	1460	-	4580	mcd
Spectral bandwidth at 50% IV	△λ	-	16	-	nm
Viewing Angle	$2\theta_{1/2}$	-	60	-	Deg
Forward Voltage	V_F	1.8	-	2.4	V
Reverse Current	I_R (V_R=5V)	-	0.2	10	μA
Thermal Resistance junction/solder point	Rth(j-sp)real	-	116	143	K/W
Electrical Thermal Resistance junction/solder point with efficiency η=32%	Rth(j-sp)elec	-	79	103	K/W

ELECTRICAL CHARACTERISTICS - I_F=20mA, Ts=25℃, RH 60%, Tol. :±0.05V

PART CODE	FORWARD VOLTAGE – VF (V)	DOMINANT WAVELENGTH- DWL (NM)	LUMINOUS INTENSITY- IV (MCD)
BDCER000000S00	1.8~2.4	616~628	1460~4580

BIN CODE LIST

PARAMETERS	SYMBOL	VALUES	TOLERANCE	UNIT
Forward Voltage Rank (VF) @IF=20mA, Ts=25℃, RH60%	00	1.8~2.4	±0.05	V
	Va	1.8~1.95		
	Vb	1.95~2.1		
	Vc	2.1~2.25		
	Vd	2.25~2.4		
Dominant Wavelength Rank (DWL) @IF=20mA, Ts=25℃, RH60%	00	616~628	±1.5	nm
	WF	616~620		
	WG	620~624		
	WH	624~628		
Luminous Intensity Rank (IV) @IF=20mA, Ts=25℃, RH60%	00	1460~4580	±5.0%	mcd
	FB	1460~1890		
	FC	1890~2290		
	FD	2290~2880		
	FE	2880~3600		
	FF	3600~4580		

OPTICAL & ELECTRICAL CHARACTERISTICS CURVES - IF=20mA, Ts=25℃, RH 60% - For Reference Only

Figure 1. Relative Spectral Emission, Irel=f(λ)

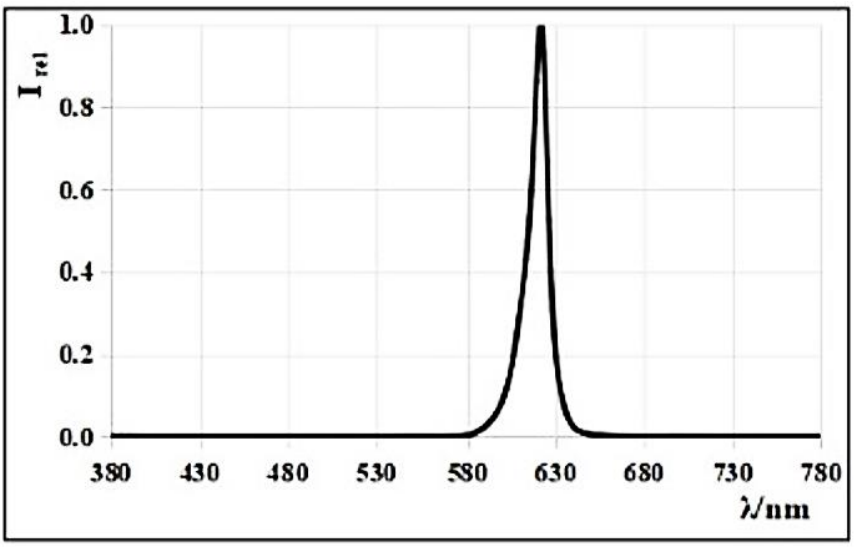
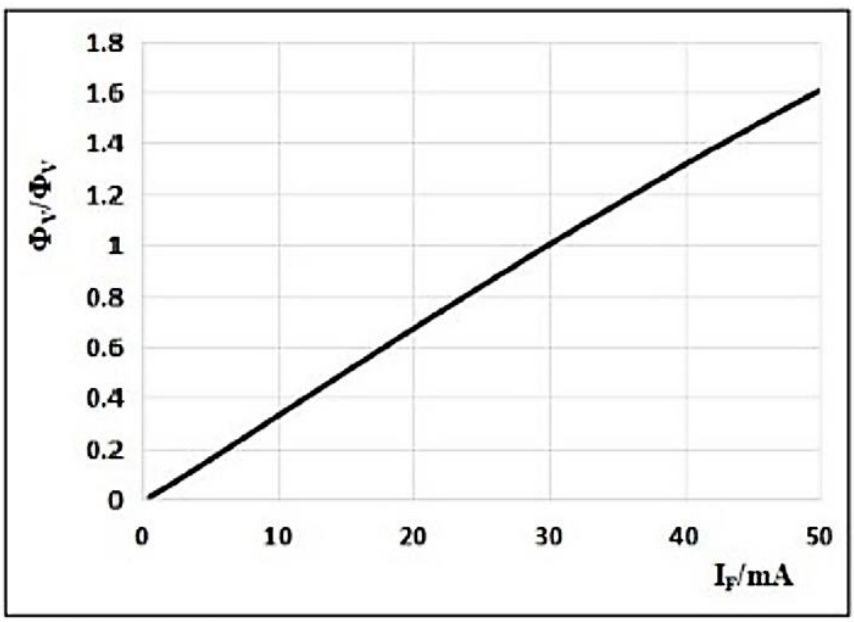


Figure 2. Forward Current Vs. Relative Intensity, ΦV/Φv(20mA)= f (IF)



OPTICAL & ELECTRICAL CHARACTERISTICS CURVES - IF=20mA, Ts=25℃, RH 60% - For Reference Only

Figure 3. Forward Voltage Vs. Forward Current, IF = f (VF)

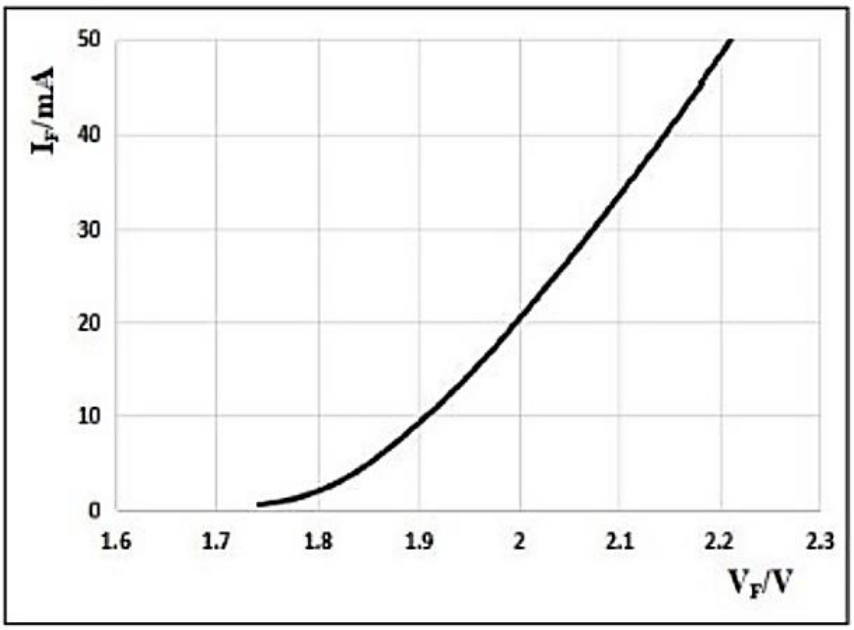
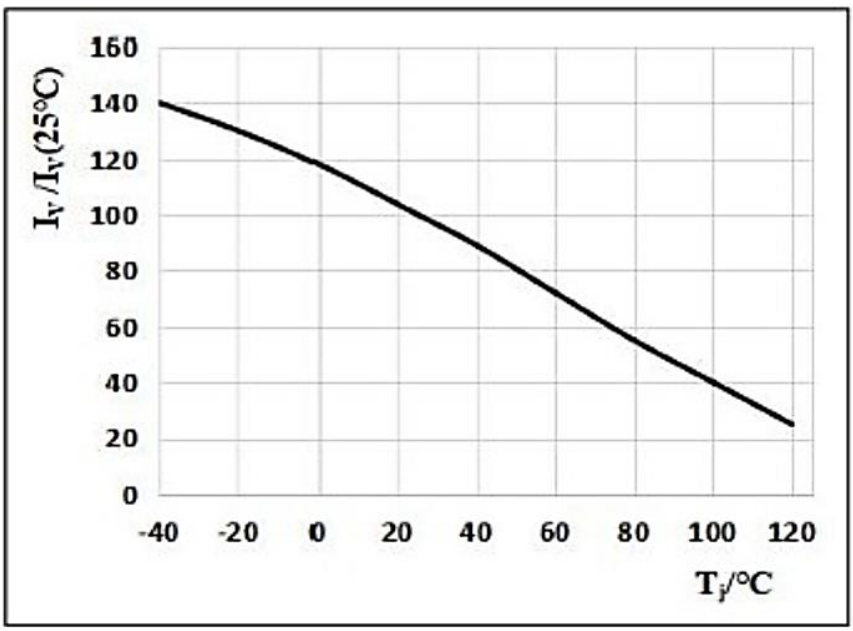


Figure 4. Junction Temperature Vs. Relative Intensity



OPTICAL & ELECTRICAL CHARACTERISTICS CURVES - IF=20mA, Ts=25℃, RH 60% - For Reference Only

Figure 5. Junction Temperature Vs. △VF, △VF = VF- VF(25℃)=f(Tj)

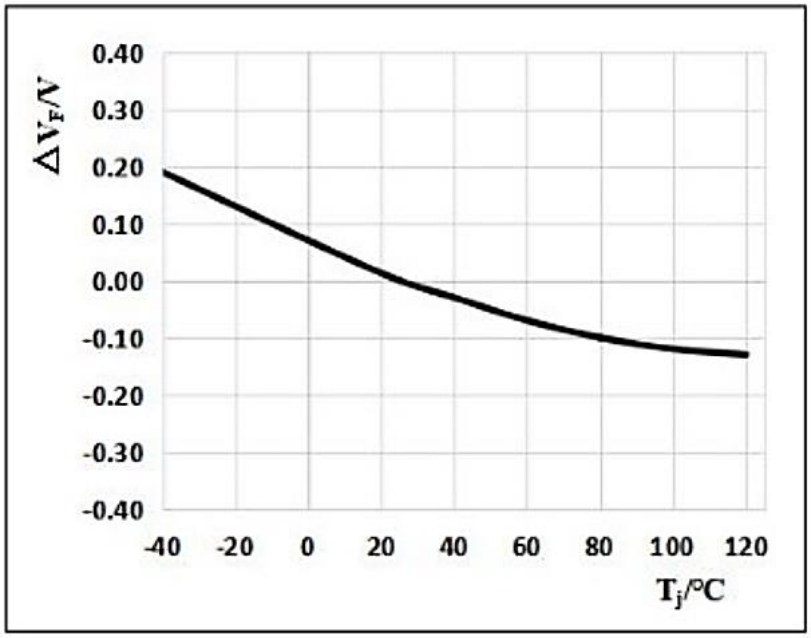
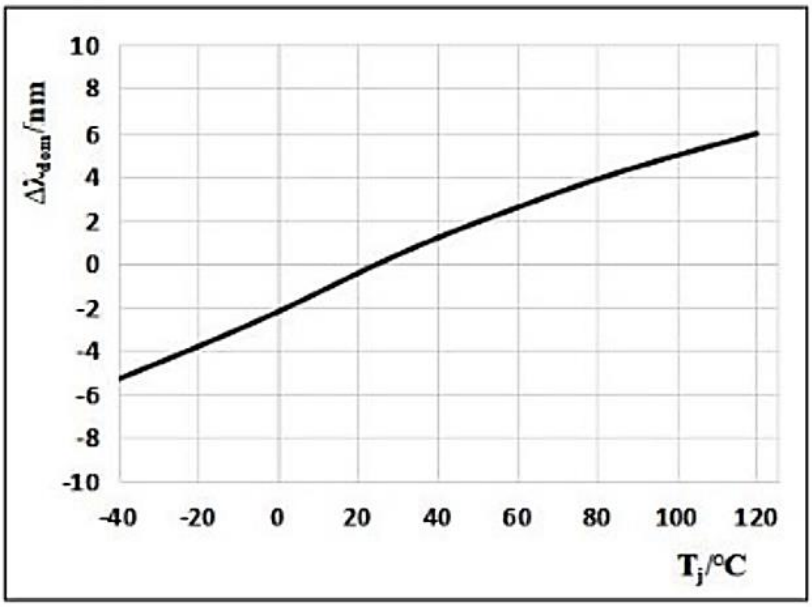


Figure 6. Junction Temperature Vs. Δλdom, Δλdom = λdom - λdom (25°C) =f(Tj)



OPTICAL & ELECTRICAL CHARACTERISTICS CURVES - IF=20mA, Ts=25℃, RH 60% - For Reference Only

Figure 7. Ts Vs. Max. Permissible IF, IF = f(Ts)

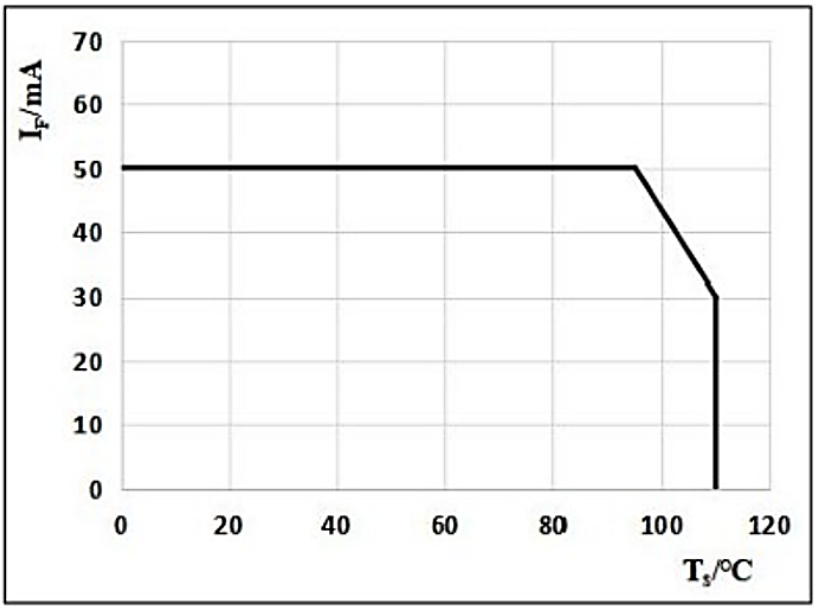
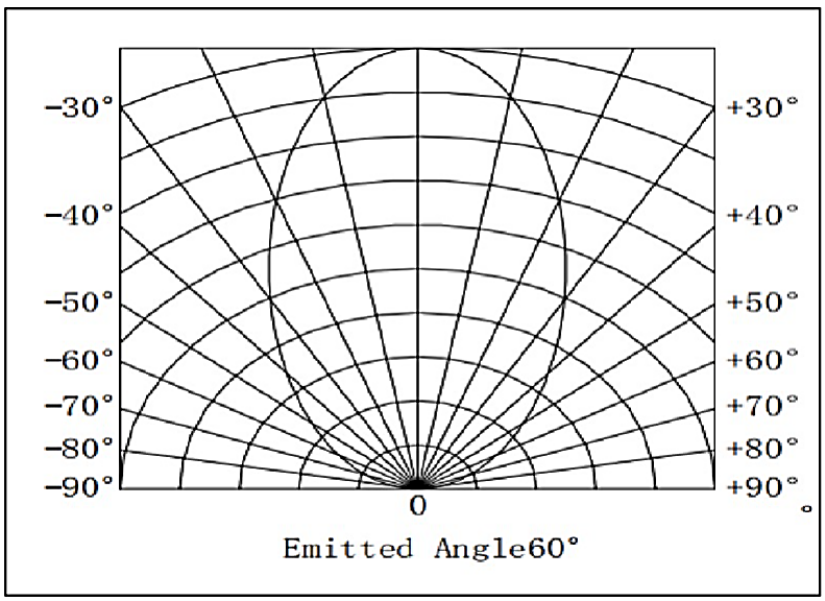
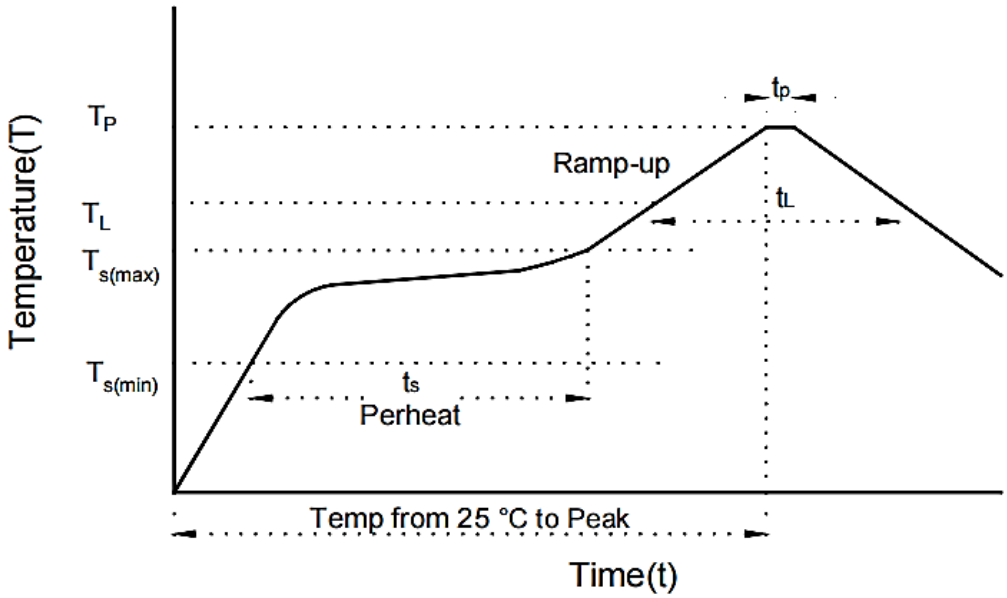


Figure 8 Radiation Diagram, I rel = f (Φ)



SUGGESTED REFLOW PROFILE - For Reference Only

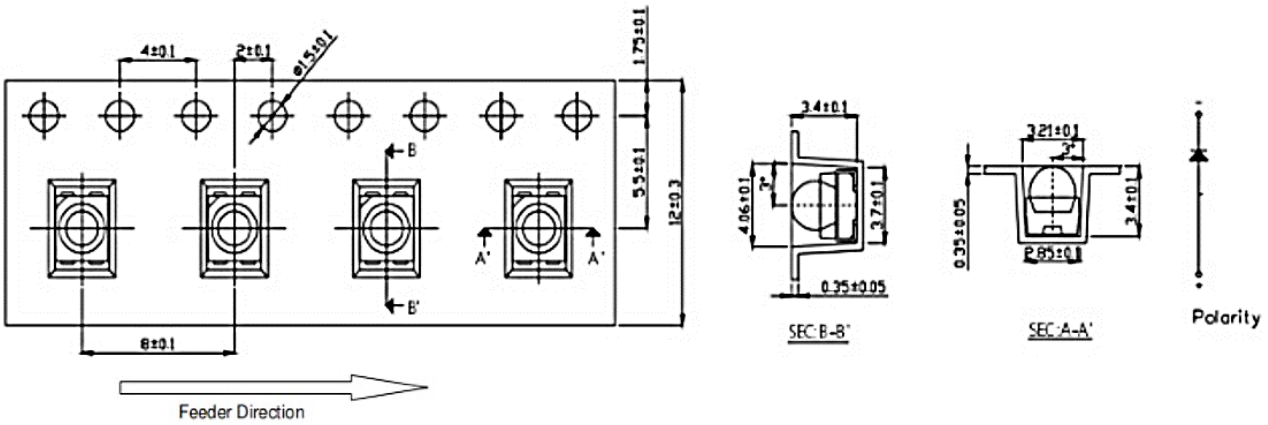


PROFILE FEATURE		PB-FREE ASSEMBLY
Average Ramp-up Rate (T_L Max to T_p)		3°C/second Max
Preheat	Temperature Min (T_s Min.)	150°C
	Temperature Max (T_s Max.)	200°C
	Time (t_s Min. to t_s Max.)	60 ~ 120 seconds
Time maintained above	Temperature (T_L)	217°C
	Time (t_L)	60 ~ 150 seconds
Peak/Classification Temperature (T_p)		260 °C
Time within 5°C of actual Peak Temperature (t_p)		30 seconds Max.
Ramp-down Rate		6 °C /Second Max.
Time 25 °C to Peak Temperature		8 Minutes Max.
Suggest reflow times		3 Times Max.

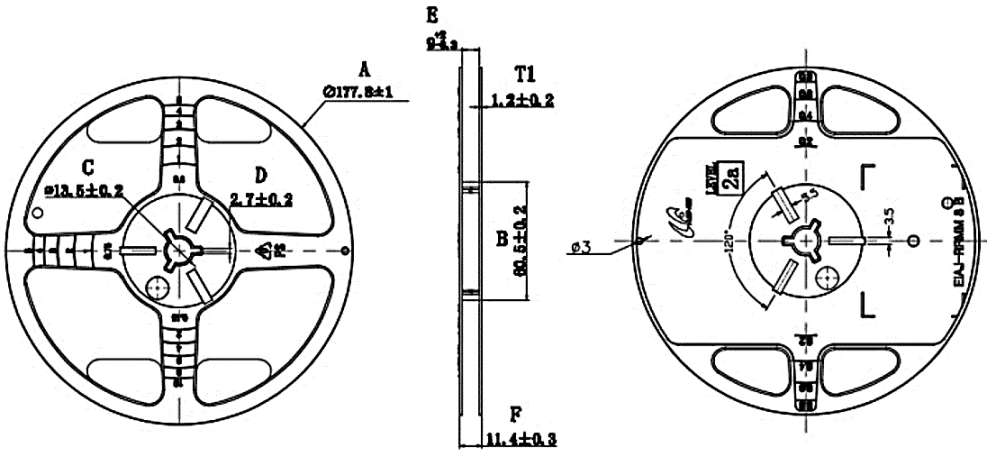
TAPE/REEL - Unit: mm

- All Devices are packed in accordance with EIA standard RS-481-A, 2000pcs/Reel
- Cumulative Tolerance : Cumulative Tolerance/10 pitches to be ±0.2mm
- Adhesion Strength of Cover Tape Adhesion strength to be 0.1-0.7N when the cover tape is turned off from the carrier tape at the angle of 10˚ to the carrier tape.
- Moisture Resistant Package

Tape



Reel



APPLICATION NOTES - Part I

- Storage: To avoid the moisture penetration, we recommend store in a dry box with a desiccant, The maximum storage temperature range is 40℃ and a maximum humidity of RH60%.
- Use Precaution after Opening the Packaging: Recommend conditions after opening the package

  a) Sealing *b)* Temperature : 30℃ Humidity: Less than RH50% *c)* Recommend to use up before 72hrs after opening the package.
- If the package has been opened more than 4 weeks(MSL_2a) or the color desiccant changes, LED Components should be dried for 12hrs at 60±5℃.
- Do not apply mechanical force or excess vibration during the cooling process to normal temperature after soldering.
- Do not rapidly cool device after soldering.
- The LED should not be mounted on warped portion of PCB.
- The LED should not be used in any type of fluid such as water, oil, organic solvent and etc. When washing is required, IPA (Isopropyl Alcohol) should be used.
- When the LEDs are in operation the maximum current should be decided after measuring the package temperature.
- Long time exposure of sunlight or occasional UV exposure will cause lens discoloration.
- The driving circuit must be designed to allow forward voltage only when it is ON or OFF. If the reverse voltage is applied to LED, migration can be generated resulting in LED damage.
- LEDs are sensitive to Electro-Static Discharge (ESD). Below is a list of suggestions that BND purposes to minimize these effects.
- The products are sensitive to static electricity or surge voltage. ESD can damage a die and it’s Reliability. When handing the products, the following measures against electrostatic discharge are strongly recommended:

APPLICATION NOTES - Part II

a) Increase in reverse leakage current lowered turn-on voltage

b) Abnormal emissions from the LED at low current LED

The following recommendations are suggested to help minimize the potential for an ESD event.

- One or more recommended work area suggestions:

a) Dissipating static charge with conductive materials

b) Preventing charge generation with moisture

c) ESD safe storage containers ESD

- One or more personnel suggestion options:

a) Antistatic wrist-strap b) Antistatic material shoes c) Antistatic clothes

- Environmental controls: Humidity control (ESD gets worse in a dry environment).
- Handing Precautions: During processing, mechanical stress on the surface should be minimized as much as possible. Sharp objects of all types should not be used to pierce the sealing compound. In general, LEDs should only be handled from the side. By the way, this also applies to LEDs Without a silicone sealant, since the surface can also become scratched.
- NextGen suggests using isopropyl alcohol for cleaning. In case other solvents are used, it must be assured that these solvents do not dissolve the package or resin. Please do not mold this products into another resin (epoxy, urethane, etc.) and do not handle this Product with acid or sulfur material in sealed space.

The following recommendations are suggested to help minimize the potential for an ESD event.

- One or more recommended work area suggestions:

a) Dissipating static charge with conductive materials

b) Preventing charge generation with moisture

c) ESD safe storage containers ESD

- One or more personnel suggestion options:

a) Antistatic wrist-strap b) Antistatic material shoes c) Antistatic clothes

- Environmental controls: Humidity control (ESD gets worse in a dry environment)

APPLICATION NOTES - Part III

- Handing Precautions: During processing, mechanical stress on the surface should be minimized as much as possible. Sharp objects of all types should not be used to pierce the sealing compound. In general, LEDs should only be handled from the side. By the way, this also applies to LEDs Without a silicone sealant, since the surface can also become scratched.
- NextGen suggests using isopropyl alcohol for cleaning. In case other solvents are used, it must be assured that these solvents do not dissolve the package or resin. Please do not mold this products into another resin (epoxy, urethane, etc.) and do not handle this Product with acid or sulfur material in sealed space.
- The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems).Within the risk grouping system of this IEC standard, the device specified in this data sheet falls into the class exempt group (exposure time 10000 s). Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.
- Subcomponents of this device contain, in addition to other substances, metal filed materials including silver. Metal filed materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits Notes are described in the IEC60810.

GLOSSARY

- Brightness: Brightness values are measured during a current pulse of typically 20ms, with an internal reproducibility of ±5 % .
- Wavelength: The wavelength is measured at a current pulse of typically 20ms, with an internal reproducibility of ±1.5 nm.
- Forward Voltage: The forward voltage is measured during a current pulse of typically 20ms, with an internal reproducibility of ±0.05 V.
- Reverse Operation: Continuous reverse operation is not allowed.
- Thermal Resistance: RthJA results from mounting on PC board.
- Typical Values: Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- Characteristic curve: In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.

IMPORTANT NOTES AND DISCLAIMER

1. ROHS COMPLIANCE: The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU RoHS Directive (EU) 2015/863 EC (RoHS3). RoHS Test Report for this product can be obtained can be obtained at Download Center.
2. REACH COMPLIANCE: REACH substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, REACH Test Report for this product can be obtained can be obtained at Download Center.
3. All Product parametric performance is indicated in the Electrical Characteristics for the listed herein test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
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8. *NextGen* requires that customers first obtain an RMA (Returned Merchandise Authorization) number prior to returning any products. Returns must be made within 30 days of the date of invoice, be in the original packaging, unused and like-new condition. At the time of quoting or purchasing, a product may say that it is Non-Cancelable/ Non-Returnable (NCNR). These products are not returnable and not refundable.